

**Listing of Claims:**

This listing of claims replaces all prior versions and listings of claims in the application.

1. (Currently amended) An n-type semiconductor diamond, characterized by: by a crystalline perfectness whereby:

it has impurity atoms constituted by sulfur atoms forming a single donor level of 0.38 eV;

it has a carrier mobility's temperature dependency which at a temperature (T) range in excess of the room temperature is T-3/2 dependent, and

it has a diamond peak in its Raman spectrum, whose half width is 2.6 cm<sup>-1</sup>;

a crystalline perfectness whereby:

light emission by excitons is observable; and

a crystalline perfectness whereby:

a distinct Kikuchi pattern in its reflection electron diffraction analysis is observable;

~~wherein said n-type semiconductor diamond exhibits crystal completeness~~ sufficient to allow operation of said n-type semiconductor diamond as p-n junction device.

2. (Previously presented) An n-type semiconductor diamond as set forth in claim 1, characterized in that at a room temperature it has a carrier concentration not less than 1.4x10<sup>-13</sup> cm<sup>-3</sup> and a carrier mobility not less than 580 cm<sup>2</sup>V<sup>-1</sup>s<sup>-1</sup>.

3. (Currently amended) A method of making an n-type semiconductor diamond, characterized in that it comprises:

mechanically polishing a diamond substrate to make it in an inclined diamond substrate, which is formed by mechanically polishing a diamond (100) face oriented substrate so that its face normal is inclined at an angle between 1.5 and 6 degrees with respect to its <100> direction in a plane made by either its <100> and <010> directions or its <100> and <001> directions;

subjecting a surface of said inclined diamond substrate to a smoothening treatment make it ~~eve~~ even; and

exciting a raw material gas made of a volatile hydrocarbon compound, a sulfur compound and a hydrogen gas by a microwave plasma while maintaining at a given temperature said substrate surface smoothened as aforesaid to cause n-type semiconductor diamond to grow epitaxially on said smoothened substrate;

~~wherein said n-type semiconductor diamond exhibits crystal completeness sufficient to allow operation of said n-type semiconductor diamond as p-n junction device.~~

4. (Previously presented) A method of making an n-type semiconductor diamond as set forth in claim 3, characterized in that said diamond substrate is a diamond (100) face oriented substrate.

5. (Canceled)

6. (Previously presented) A method of making an n-type semiconductor diamond as set forth in claim 3, characterized in that said smoothening treatment comprises a treatment of exposing said inclined substrate to the hydrogen plasma of a hydrogen pressure of 10 to 50 Torr and a microwave output of 200 to 1200 W at a substrate temperature of 700 to 1200 °C for a period of 0.5 hours to 5 hours, thereby to make even said substrate surface to consist of steps each in the order of an atomic layer.

7. (Previously presented) A method of making an n-type semiconductor diamond as set forth in claim 3, characterized in that said given substrate temperature is between 700 and 1100°C.

8-19. (Canceled)

20. (Previously presented) A method of making an n-type semiconductor diamond as set forth in claim 7, characterized in that said given substrate temperature is 830°C.